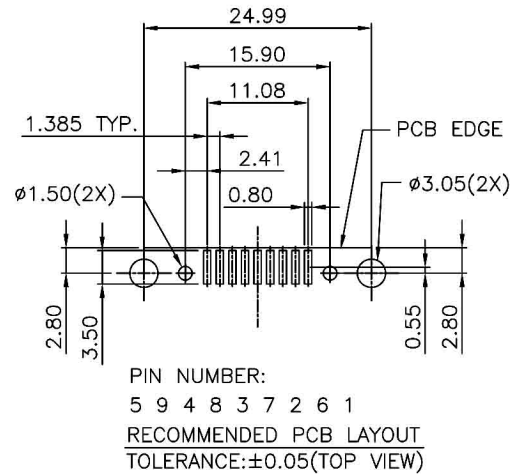
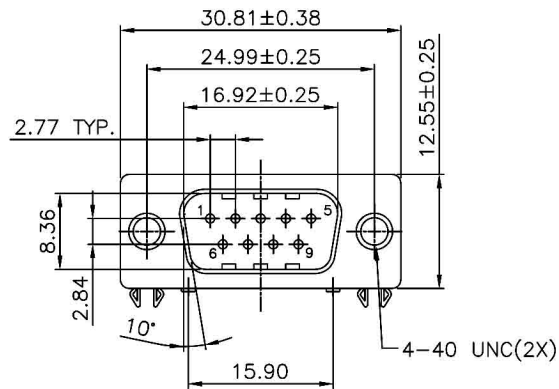


RoHS COMPLIANT

REV	ECN NO.	DESCRIPTION	DATE
A		RELEASE	ARP. 22'05
B		ADD. RoHS	SEP. 11'07
△		REDRAW	MAY. 12'15



NOTES:

1.MATERIAL:

HOUSING:HIGH TEMP THERMOPLASTIC,UL94V-0,COLOR:BLACK

PC 99 COLORFUL INSULATOR:PANTONE#322C

TERMINAL:PHOSPHOR BRONZE

METAL SHELL:SPCC

BOARD LOCK & NUT:BRASS

2.PLATING:

TERMINAL:

CONTACT AREA:SELECTIVE GOLD(Au) PLATING

SOLDER TAIL:TIN(Sn),THICKNESS=100 MICROINCH MIN.(2.54 MICROINCH MIN.)

UNDER PLATE:NICKEL(Ni),THICKNESS=50 MICROINCH MIN.(1.27 MICROMETER MIN.)

METAL SHELL:

NICKEL(Ni),THICKNESS=80 MICROINCH MIN.(2.032 MICROMETER MIN.)

UNDER PLATE:COPPER(Cu),THICKNESS=40 MICROINCH MIN.(1.016 MICROMETER MIN.)

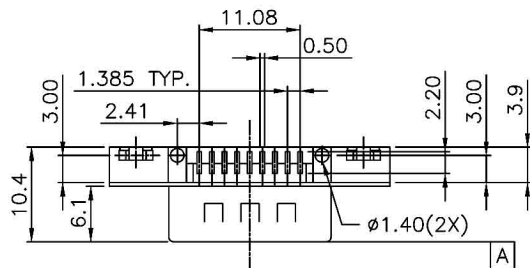
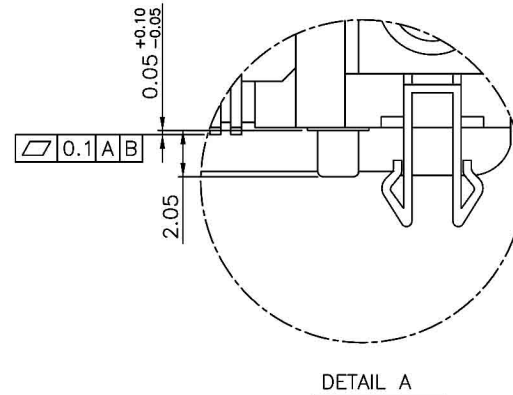
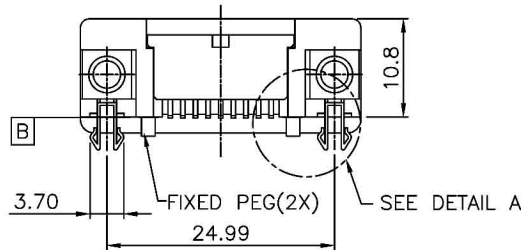
BOARD LOCK:

TIN(Sn),THICKNESS=80 MICROINCH MIN.(2.032 MICROMETER MIN.)

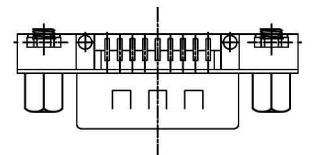
UNDER PLATE:NICKEL(Ni),THICKNESS=50 MICROINCH MIN.(1.27 MICROMETER MIN.)

NUT:NICKEL(Ni),THICKNESS=50 MICROINCH MIN.(1.27 MICROMETER MIN.)

3.RECOMMENDED PCB THICKNESS:1.60±0.05mm



N=Without Jackscrews

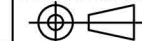


Y=With Jackscrews

TOLERANCE UNLESS
OTHERWISE SPECIFIED

LINEAR	ANGLE
X. ±	X° ±
.X ± 0.30	.X° ±
.XX ± 0.20	.XX° ±
.XXX±	.XXX° ±
APPD	
CHKD	
DRAW	Z

PROJECTION



UNITS

MM

SCALE

SIZE

A4

MAY. 12'2015



ELECTRIC CO., LTD.

TITLE
D-Sub 9 Pos. Male
Right Angle SMT Slim
Type

CPART NO.

PART NO.

DENM09PN*1*TS

CAD NO. I0040A

F:\PDF\DSUB\DSUB-0093

SHEET

1 OF 1

圖面編號:GTKSD1455-C(1)